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Vishay Siliconix

RoHS

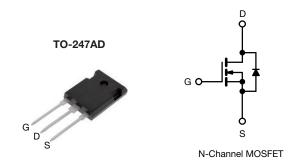
COMPLIANT

HALOGEN

FREE

E Series Power MOSFET with Fast Body Diode

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	700			
R _{DS(on)} typ. at 25 °C (Ω)	V _{GS} = 10 V 0.041			
Q _g max. (nC)	371			
Q _{gs} (nC)	65			
Q _{gd} (nC)	93			
Configuration	Single			



FEATURES

- Fast body diode MOSFET using E series technology
- Reduced t_{rr}, Q_{rr}, and I_{RRM}
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Low switching losses due to reduced Q_{rr}
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Lighting
- High-intensity lighting (HID)
- Light emitting diodes (LEDs)
- Consumer and computing
 - ATX power supplies
- Industrial
 - Welding
- Battery chargers
- · Renewable energy
 - Solar (PV inverters)
- Switching mode power supplies (SMPS)
- Applications using the following topologies
 - LLC
 - Phase shifted bridge (ZVS)
 - 3-level inverter
 - AC/DC bridge

ORDERING INFORMATION	
Package	TO-247AD
Lead (Pb)-Free and Halogen-Free	SiHW61N65EF-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	- 20 O, am	OOO OLITOI WIL	-			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	650	V	
Gate-Source Voltage			V_{GS}	± 30	V	
Continuous Drain Current (T. – 150 °C)	V _{GS} at 10 V	T _C = 25 °C	- I _D	64	А	
Continuous Drain Current (T _J = 150 °C)		T _C = 100 °C		41		
Pulsed Drain Current ^a			I _{DM}	199		
Linear Derating Factor				4.2	W/°C	
Single Pulse Avalanche Energy b			E _{AS}	1142	mJ	
Maximum Power Dissipation			P_{D}	520	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	T _J = 125 °C		-11//-14	70	\//n -	
Reverse Diode dV/dt ^d			dV/dt	50	- V/ns	
Soldering Recommendations (Peak temperature) c For 10 s			300	°C		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $V_{DD} = 140 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 28.2 \,\text{mH}$, $R_g = 25 \,\Omega$, $I_{AS} = 9 \,\text{A}$.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, dI/dt = 500 A/ μ s, starting $T_J = 25$ °C.



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	40	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.24	C/VV	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 10 mA	-	0.81	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$		2.0	-	4.0	V
Cata Caumaa Laakama		V _{GS} = ± 20 V		-	-	± 100	nA
Gate-Source Leakage	I _{GSS}	V _{GS} = ± 30 V		-	-	± 1	μΑ
Zoro Cata Valtago Prain Current	1	V _{DS} = 520 V, V _{GS} = 0 V		-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 520 \text{ V}$	V, V _{GS} = 0 V, T _J = 125 °C	-	-	500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	$I_D = 30.5 A$	-	0.041	0.047	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	30 V, I _D = 30.5 A	-	23	-	S
Dynamic							
Input Capacitance	C _{iss}	V _{GS} = 0 V,		=.	7407	-	
Output Capacitance	Coss		$V_{DS} = 100 \text{ V},$		351	-	
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz	-	3	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	., .,	V4- 500 V V 0 V	-	233	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	$V_{DS} = 0$	V to 520 V, V _{GS} = 0 V	-	939	-	
Total Gate Charge	Q_g			-	247	371	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$I_D = 30.5 \text{ A}, V_{DS} = 520 \text{ V}$	-	65	-	nC
Gate-Drain Charge	Q _{gd}			-	93	-	
Turn-On Delay Time	t _{d(on)}			-	59	89	
Rise Time	t _r	V _{DD} =	520 V, I _D = 30.5 A,	-	107	161	
Turn-Off Delay Time	t _{d(off)}	V _{GS} = 10 V I _D = 30.5 A, V _{DS} = 520 V - 65 - 93 - 59		326	ns		
Fall Time	t _f			-	133	200	
Gate Input Resistance	R _g	f = 1	MHz, open drain	0.5	1	2	Ω
Drain-Source Body Diode Characteristics	S						
Continuous Source-Drain Diode Current	Is	MOSFET sym	bol	-	-	64	^
Pulsed Diode Forward Current	I _{SM}	integral revers	integral reverse p - n junction diode		-	199	- A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 30.5 A, V _{GS} = 0 V		-	0.9	1.2	V
Reverse Recovery Time	t _{rr}			-	212	474	ns
Reverse Recovery Charge	Q _{rr}			3.8	μC		
Reverse Recovery Current	I _{RRM}	u/ui =	100 AVμS, VR = 400 V	-	18	-	Α

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

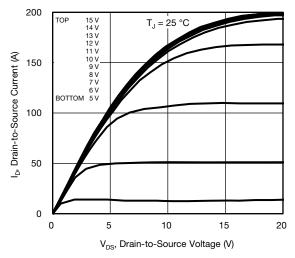


Fig. 1 - Typical Output Characteristics

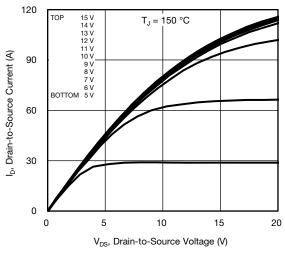


Fig. 2 - Typical Output Characteristics

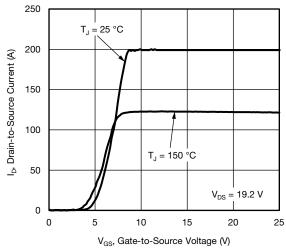


Fig. 3 - Typical Transfer Characteristics

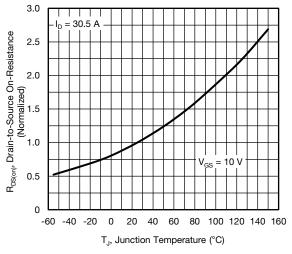


Fig. 4 - Normalized On-Resistance vs. Temperature

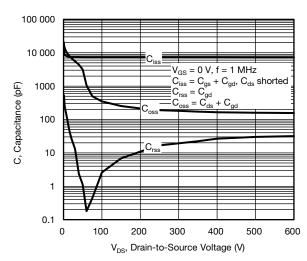


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

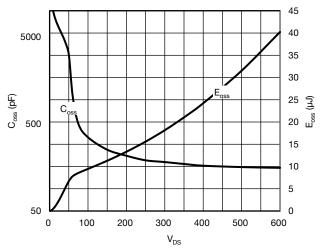


Fig. 6 - Coss and Eoss vs. VDS



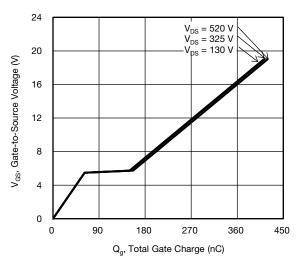


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

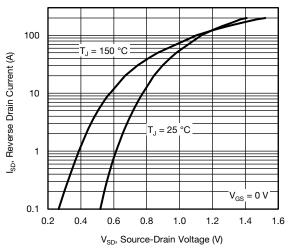


Fig. 8 - Typical Source-Drain Diode Forward Voltage

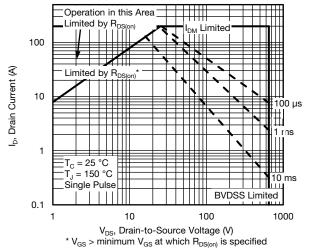


Fig. 9 - Maximum Safe Operating Area

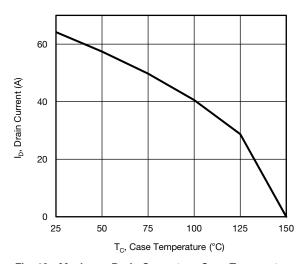


Fig. 10 - Maximum Drain Current vs. Case Temperature

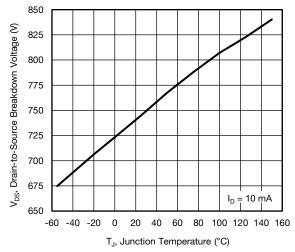


Fig. 11 - Temperature vs. Drain-to-Source Voltage



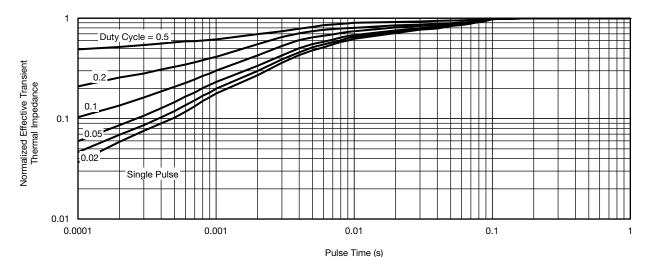
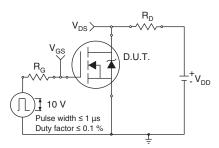


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case



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Fig. 13 - Switching Time Test Circuit

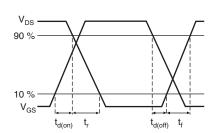


Fig. 14 - Switching Time Waveforms

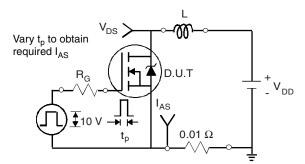


Fig. 15 - Unclamped Inductive Test Circuit

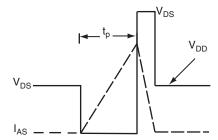


Fig. 16 - Unclamped Inductive Waveforms

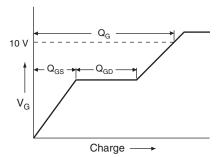


Fig. 17 - Basic Gate Charge Waveform

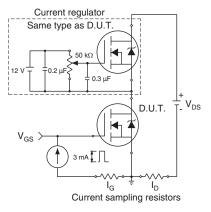
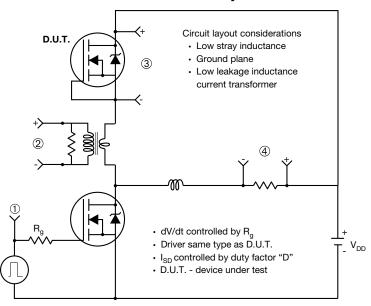


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



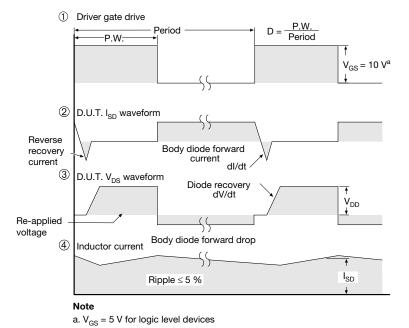
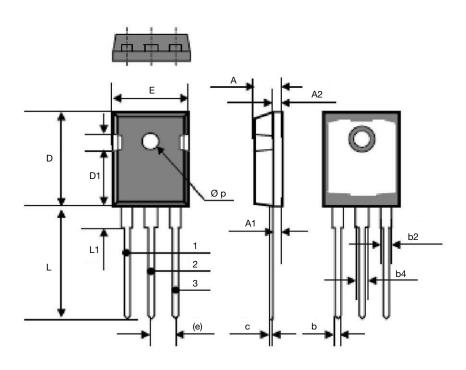


Fig. 19 - For N-Channel

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TO-247AD (High Voltage)



DIM.	MILLIM	IETERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.70	5.31	0.185	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b2	1.65	2.41	0.065	0.095	
b4	2.59	3.43	0.102	0.135	
С	0.61 BSC		0.024 BSC		
D	20.80	21.46	0.819	0.845	
D1	3.68	5.49	0.145	0.216	
(e)	5.46	BSC	0.215	BSC	
Е	15.49	16.26	0.610	0.640	
L	19.81	20.32	0.780	0.800	
L1	4.06	4.50	0.160	0.177	
Øр	3.51	3.66	0.138	0.144	

ECN: S17-0178-Rev. B, 06-Feb-17

DWG: 6010



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